PCN Number:		20141007001					PCN Date:		:	10/09/2014	
Title:	Title: Die Conversion for select AUP LL Devices in DBV, DCK and DRL Packages										
Customer Contact:		<u>PCN</u>	<u>Manager</u>		Phone: +1(214)480-603		Dept:		Qι	uality Services	
Proposed 1 st Ship Date		e:	01/	D1/09/2015 Estimated Sample Availability:					ate provided at mple request.		
Change	Туре:										
Assembly Site				Assembly Process			Assembly Materials		Materials		
Design				Electrical Specification		Mecha	nica	al Specification			
Test Site				Packing/Shipping/Labeling			Test Process				
☐ Wafer Bump Site				Wafer Bump Material			Wafer Bump Process				
Wafer Fab Site				Wafer Fab Materials			Wafer Fab Process				
				Part i	number	r ch	nange		•		
PCN Details											

Description of Change:

This change notification is to announce a Die Conversion for select AUP LL Devices. The Die Revision will change from X/A to C. Devices affected by this change are listed in the product affected section of this notification. There will be no change to the data sheet.

Reason for Change:

Continuity of Supply

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

Reliability & electrical characterization evaluation showed no adverse impacts.

Changes to product identification resulting from this PCN:

Die Rev designator will change as shown in table & sample label below:

Current	New
Die Rev [2P]	Die Rev [2P]
X/A	C

Sample product shipping label to indicate die rev location (not actual product label)







Die Rev Marking:

Current = X/A

New = C

Product Affected:			
SN74AUP1G00DBVR	SN74AUP1G08DBVR	SN74AUP1G240DBVR	SN74AUP1G58DCKT
SN74AUP1G00DBVT	SN74AUP1G08DBVT	SN74AUP1G240DBVT	SN74AUP1G58DRLR
SN74AUP1G00DCKT	SN74AUP1G08DCKT	SN74AUP1G240DCKT	SN74AUP1G79DBVR
SN74AUP1G00DRLR	SN74AUP1G08DRLR	SN74AUP1G32DBVR	SN74AUP1G79DBVT
SN74AUP1G02DBVR	SN74AUP1G125DBVR	SN74AUP1G32DBVT	SN74AUP1G79DCKT
SN74AUP1G02DBVT	SN74AUP1G125DBVT	SN74AUP1G32DCKT	SN74AUP1G79DRLR
SN74AUP1G02DCKT	SN74AUP1G125DCKT	SN74AUP1G32DRLR	SN74AUP1G80DBVR
SN74AUP1G02DRLR	SN74AUP1G125DRLR	SN74AUP1G34DBVR	SN74AUP1G80DBVT
SN74AUP1G04DBVR	SN74AUP1G126DBVR	SN74AUP1G34DBVT	SN74AUP1G80DCKT
SN74AUP1G04DBVT	SN74AUP1G126DBVT	SN74AUP1G34DCKT	SN74AUP1G97DBVR
SN74AUP1G04DCKT	SN74AUP1G126DCKT	SN74AUP1G34DRLR	SN74AUP1G97DBVT
SN74AUP1G04DRLR	SN74AUP1G126DRLR	SN74AUP1G57DBVR	SN74AUP1G97DCKR
SN74AUP1G06DBVR	SN74AUP1G14DBVR	SN74AUP1G57DBVT	SN74AUP1G97DCKT
SN74AUP1G06DBVT	SN74AUP1G14DBVT	SN74AUP1G57DCKR	SN74AUP1G97DRLR
SN74AUP1G06DCKT	SN74AUP1G14DCKT	SN74AUP1G57DCKT	SN74AUP1G98DBVR
SN74AUP1G06DRLR	SN74AUP1G14DRLR	SN74AUP1G57DRLR	SN74AUP1G98DBVT
SN74AUP1G07DBVR	SN74AUP1G17DBVR	SN74AUP1G57DRLR-P	SN74AUP1G98DCKR
SN74AUP1G07DBVT	SN74AUP1G17DBVT	SN74AUP1G58DBVR	SN74AUP1G98DCKT
SN74AUP1G07DCKT	SN74AUP1G17DCKT	SN74AUP1G58DBVT	SN74AUP1G98DRLR
SN74AUP1G07DRLR	SN74AUP1G17DRLR	SN74AUP1G58DCKR	

Reference Qualification Data: (Approved 11/29/2010)

This qualification has been specifically developed for the validation of this change. The qualification data validates that the proposed change meets the applicable released technical specifications. **Qualification Device Construction Details:** Qualification Vehicle #1: SN74AUP1G00DCKR Wafer Fab Site: **FREISING** Wafer Process: P9722 Protective Die Coating: 10KACN X Test Results Qualification: Plan Sample Size Reliability Test Conditions (PASS/FAIL) Electrical Char Approved by Product Engineer PASS 1500 V ESD (CDM) 3/0 Manufacturability Wafer Fab (per mfg. Site specification) PASS Manufacturability-TQ Assembly (per mfg. Site specification) **PASS** Qualification tests "pass" on zero fails for each test Notes: Qualification Vehicle #2: SN74AUP1G02DCKR Wafer Fab Site: **FREISING** P9722 Wafer Process: Protective Die Coating: 10KACN

Qualification: Plan					
Reliability Test	Conditions	Sample Size (PASS/FAIL)			
Electrical Char	Approved by Product Engineer		PASS		
ESD (CDM)	1500 V		3/0		
Manufacturability	Wafer Fab (per mfg. Site specif	fication)	PASS		
Manufacturability-TQ	Assembly (per mfg. Site specifi	cation)	PASS		
Notes: Qualificati	on tests "pass" on zero fails for	each test			
Ç	Qualification Vehicle #3: SN74A	AUP1G04DCKR			
Wafer Fab Site	FREISING Wafer Process:		P9722		
Protective Die Coating	: 10KACN				
Qualification: Plan	n 🛛 Test Results				
Reliability Test	Conditions		Sample Size (PASS/FAIL)		
Electrical Char	Approved by Product Engineer		PASS		
ESD (CDM)	1500 V		3/0		
Manufacturability	Wafer Fab (per mfg. Site specif	fication)	PASS		
Manufacturability-TQ	Assembly (per mfg. Site specifi	ication)	PASS		
	on tests "pass" on zero fails for				
C	Qualification Vehicle #4: SN74	AUP1G06DCKR	T		
Wafer Fab Site	: FREISING	Wafer Process:	P9722		
Protective Die Coating	10KACN				
Qualification: Plan	n 🛛 Test Results				
Reliability Test	Conditions		Sample Size (PASS/FAIL)		
Electrical Char	Approved by Product Engineer		PASS		
ESD (CDM)	1500 V		3/0		
Manufacturability	Wafer Fab (per mfg. Site specification)		PASS		
Manufacturability-TQ	Assembly (per mfg. Site specification)		PASS		
Notes: Qualification tests "pass" on zero fails for each test					
Ç	Qualification Vehicle #5: SN744	UP1G07DCKR			
Wafer Fab Site	FREISING	Wafer Process:	P9722		
Protective Die Coating	: 10KACN				
Qualification: Plan X Test Results					
Reliability Test	Conditions		Sample Size (PASS/FAIL)		
Electrical Char	Approved by Product Engineer	PASS			
ESD (CDM)	1500 V		3/0		
Manufacturability	Wafer Fab (per mfg. Site specif	PASS			
Manufacturability-TQ	Assembly (per mfg. Site specifi		PASS		
Notes: Qualificati	on tests "pass" on zero fails for				

Qualification Vehicle #6: SN74AUP1G08DCKR					
Wafer Fab Site	: FREISING	Wafer Process:	P9722		
Protective Die Coating	10KACN				
Qualification: Plan	n 🛛 Test Results				
Reliability Test	Conditions	Sample Size (PASS/FAIL)			
Electrical Char	Approved by Product Engineer		PASS		
ESD (CDM)	1500 V	3/0			
Manufacturability	Wafer Fab (per mfg. Site specif	,	PASS		
Manufacturability-TQ	Assembly (per mfg. Site specifi		PASS		
	ion tests "pass" on zero fails for				
Q	ualification Vehicle #7: SN74A	UP1G125DCKR	I		
Wafer Fab Site	: FREISING	Wafer Process:	P9722		
Protective Die Coating	: 10KACN				
Qualification: Plan	n 🛚 Test Results				
Reliability Test	Conditions		Sample Size (PASS/FAIL)		
Electrical Char	Approved by Product Engineer		PASS		
ESD (CDM)	1500 V		3/0		
Manufacturability	Wafer Fab (per mfg. Site specification)		PASS		
Manufacturability-TQ	Assembly (per mfg. Site specifi	cation)	PASS		
Notes: Qualification tests "pass" on zero fails for each test					
Qualification Vehicle #8: SN74AUP1G126DCKR					
Wafer Fab Site	: FREISING	Wafer Process:	P9722		
Protective Die Coating	10KACN				
Qualification: Plan Test Results					
Reliability Test	Conditions		Sample Size (PASS/FAIL)		
Electrical Char	Approved by Product Engineer		PASS		
ESD (CDM)	1500 V		3/0		
X-Ray	Bottom Side only		5/0		
Manufacturability	Wafer Fab (per mfg. Site specification)		PASS		
Manufacturability-TQ	Assembly (per mfg. Site specifi	PASS			
Notes: Qualification tests "pass" on zero fails for each test					
Qualification Vehicle #9: SN74AUP1G14DCKR					
Wafer Fab Site	: FREISING	Wafer Process:	P9722		
Protective Die Coating	: 10KACN				

Qualification: Plan					
Reliability Test	Conditions	Sample Size (PASS/FAIL)			
Electrical Char	Approved by Product Engineer		PASS		
ESD (CDM)	1500 V		3/0		
Manufacturability	Wafer Fab (per mfg. Site specif	fication)	PASS		
Manufacturability-TQ	Assembly (per mfg. Site specifi	cation)	PASS		
-	on tests "pass" on zero fails for				
Q	ualification Vehicle #10: SN74	AUP1G17DCKR	I		
Wafer Fab Site	FREISING	Wafer Process:	P9722		
Protective Die Coating	: 10KACN				
Qualification: Plan	n 🛛 Test Results				
Reliability Test	Conditions		Sample Size (PASS/FAIL)		
Electrical Char	Approved by Product Engineer		PASS		
ESD (CDM)	1500 V		3/0		
Manufacturability	Wafer Fab (per mfg. Site specif	fication)	PASS		
Manufacturability-TQ	Assembly (per mfg. Site specifi	cation)	PASS		
	on tests "pass" on zero fails for				
Qι	ualification Vehicle #11: SN74	UP1G240DCKR			
Wafer Fab Site	: FREISING	Wafer Process:	P9722		
Protective Die Coating	10KACN				
Qualification:	n 🗵 Test Results				
Reliability Test	Conditions		Sample Size (PASS/FAIL)		
Electrical Char	Approved by Product Engineer		PASS		
ESD (CDM)	1500 V		3/0		
Manufacturability	Wafer Fab (per mfg. Site specification)		PASS		
Manufacturability-TQ	Assembly (per mfg. Site specification)		PASS		
Notes: Qualification tests "pass" on zero fails for each test					
Qualification Vehicle #12: SN74AUP1G32DCKR					
Wafer Fab Site	FREISING	Wafer Process:	P9722		
Protective Die Coating	: 10KACN				
Qualification: Plan					
Reliability Test	Conditions		Sample Size (PASS/FAIL)		
Electrical Char	Approved by Product Engineer	PASS			
ESD (CDM)	1500 V		3/0		
Manufacturability	Wafer Fab (per mfg. Site specif	PASS			
Manufacturability-TQ	Assembly (per mfg. Site specifi	PASS			
Notes: Qualificati	on tests "pass" on zero fails for	each test			

Qualification Vehicle #13: SN74AUP1G34DCKR					
Wafer Fab Site	FREISING Wafer Process		P9722		
Protective Die Coating	10KACN				
Qualification: Plan	n 🛮 Test Results				
Reliability Test	Conditions	Sample Size (PASS/FAIL)			
Electrical Char	Approved by Product Engineer		PASS		
ESD (CDM)	1500 V		3/0		
Manufacturability	Wafer Fab (per mfg. Site specif	fication)	PASS		
Manufacturability-TQ	Assembly (per mfg. Site specification)	ication)	PASS		
	on tests "pass" on zero fails for	each test			
Q	ualification Vehicle #14: SN74	AUP1G79DCKR			
Wafer Fab Site	FREISING	Wafer Process:	P9722		
Protective Die Coating	10KACN				
Qualification:	n ⊠ Test Results				
Reliability Test	Conditions		Sample Size (PASS/FAIL)		
Electrical Char	Approved by Product Engineer		PASS		
ESD (CDM)	1500 V		3/0		
Manufacturability	Wafer Fab (per mfg. Site specification)		PASS		
Manufacturability-TQ	Assembly (per mfg. Site specification)		PASS		
Notes: Qualification tests "pass" on zero fails for each test					
Qualification Vehicle #15: SN74AUP1G80DCKR					
Wafer Fab Site	FREISING	Wafer Process:	P9722		
Protective Die Coating	10KACN				
Qualification: Plan Test Results					
Reliability Test	Conditions		Sample Size (PASS/FAIL)		
Electrical Char	Approved by Product Engineer	PASS			
ESD (CDM)	1500 V		3/0		
Manufacturability	Wafer Fab (per mfg. Site specification)		PASS		
Manufacturability-TQ	Assembly (per mfg. Site specific	PASS			
, ,	on tests "pass" on zero fails for				

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
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